

General Description

The MY3N10A is the high cell density trenched N-CH MOSFET, which provides excellent $R_{DS(ON)}$ and efficiency for most of the small power switching and load switch applications.

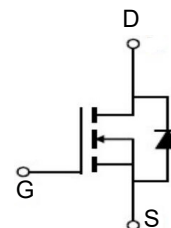
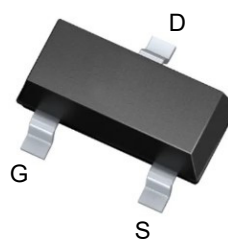


Features

V_{DSS}	100	V
I_D	2.3	A
$R_{DS(ON)}$ (at $V_{GS} = 10V$)	200	$m\Omega$
$R_{DS(ON)}$ (at $V_{GS} = 4.5V$)	230	$m\Omega$

Application

- DC-DC Converters
- Power management functions



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MY3N10A	SOT-23	MY3N10A	3000

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	V_{DS}	100	V
Gate-source Voltage	V_{GS}	± 20	V
Drain Current	I_D	2.3	A
Pulsed Drain Current ^A	I_{DM}	1.2	A
Total Power Dissipation @ $T_C=25^\circ\text{C}$	P_D	1	W
Thermal Resistance Junction-to-Ambient ^B	$R_{\theta JA}$	125	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range	T_J, T_{STG}	-55~+150	$^\circ\text{C}$

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250μA	100	-	-	V
Gate Leakage Current	I _{gss}	V _{GS} = ±20V, V _{DS} = 0V	-	-	±100	nA
Drain Cut-off Current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0V	-	-	1	μA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D = 250μA	1.1	1.5	2.5	V
Drain-Source on-state Resistance ³	R _{DS(on)}	V _{GS} = 10V, I _D = 2A	-	200	280	mΩ
		V _{GS} = 4.5V, I _D = 1.5A	-	230	310	
Dynamic Characteristics⁴						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 50V, f = 1MHz	-	440	-	pF
Output Capacitance	C _{oss}		-	14	-	
Reverse Transfer Capacitance	C _{rss}		-	10	-	
Switching Characteristics⁴						
Total gate charge	Q _g	V _{GS} = 10V, V _{DS} = 50V, I _D = 2A	-	5.3	-	nC
Gate-source charge	Q _{gs}		-	1.4	-	
Gate-drain charge	Q _{gd}		-	1.8	-	
Turn-on Time	t _{d(on)}	V _{GS} = 10V, V _{DD} = 50V, R _G = 1Ω, I _D = 2A	-	14	-	ns
Rise time	t _r		-	54	-	
Turn-off Time	t _{d(off)}		-	18	-	
Fall time	t _f		-	11	-	
Source-Drain Diode characteristics						
Body Diode Voltage ³	V _{SD}	I _S = 1A, V _{GS} = 0V	-	-	1.2	V
Continuous Source Current	I _S		-	-	2	A

Notes:

1. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C.
2. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
3. Pulse Test: Pulse width≤300μs, duty cycle≤2%
4. This value is guaranteed by design hence it is not included in the production test

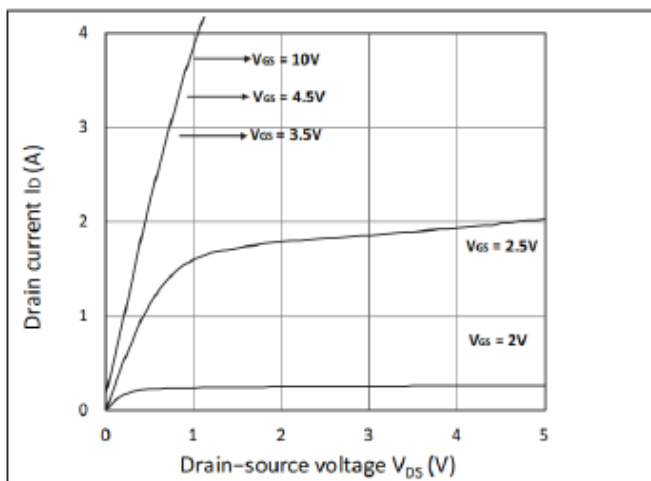


Figure 1. Output Characteristics

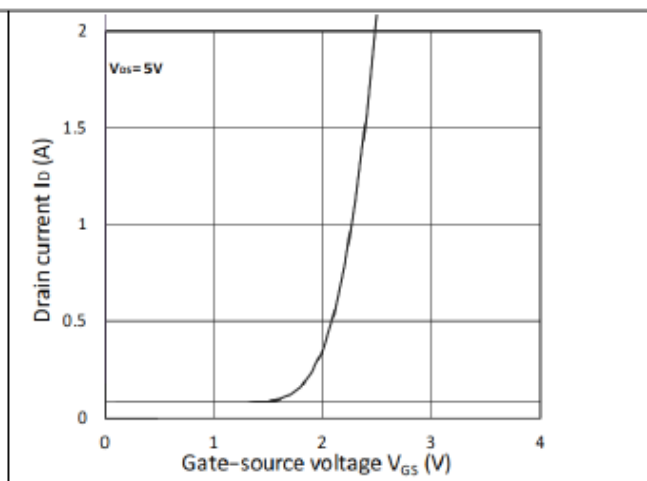


Figure 2. Transfer Characteristics

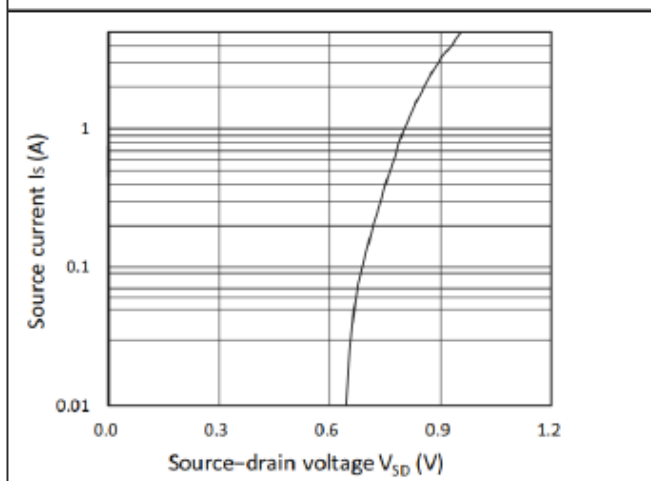


Figure 3. Forward Characteristics of Reverse

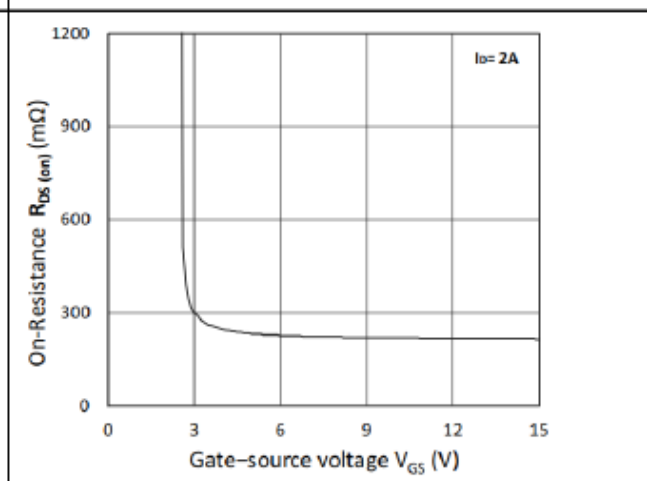


Figure 4. $R_{DS(on)}$ vs. V_{GS}

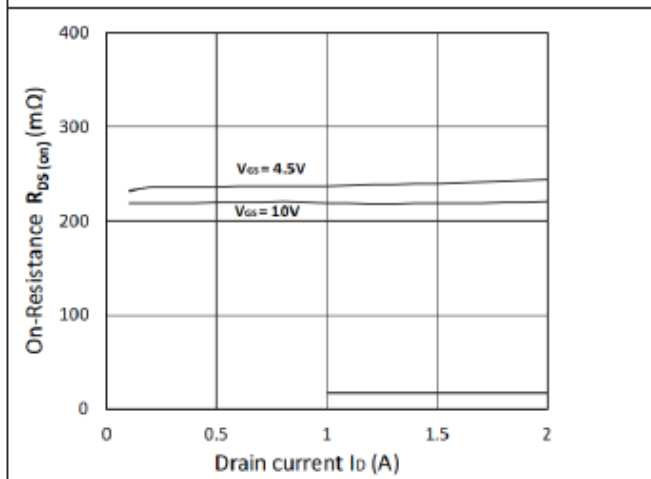


Figure 5. $R_{DS(on)}$ vs. I_D

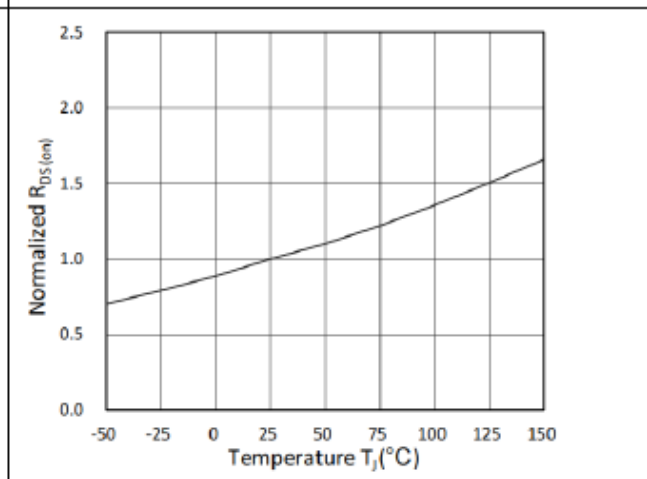


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

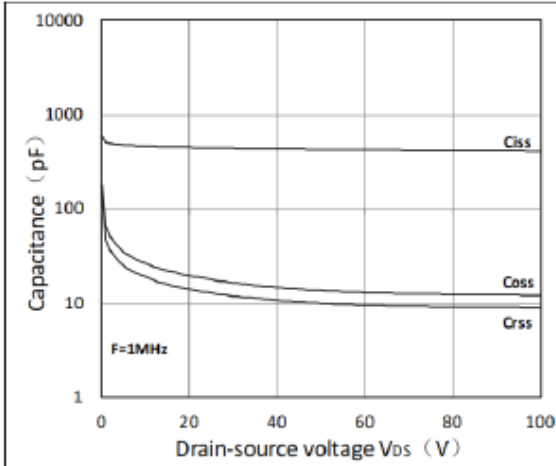


Figure 7. Capacitance Characteristics

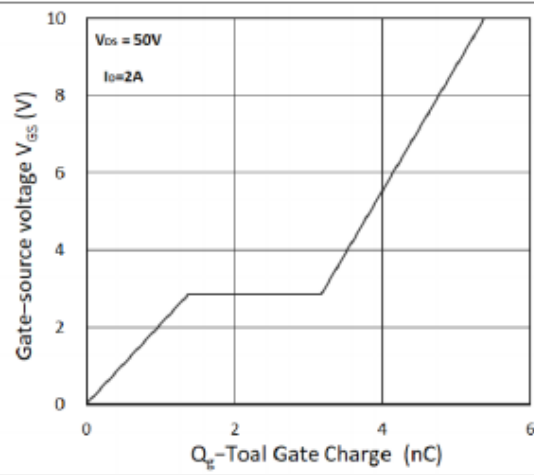
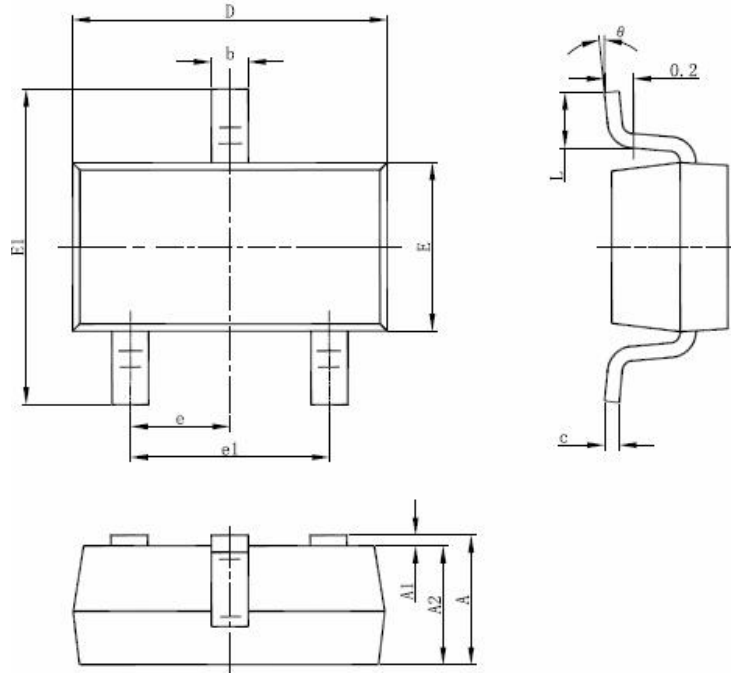


Figure 8. Gate Charge Characteristics

Package Mechanical Data-SOT-23



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°